TOSHIBA JDP2S04E

TOSHIBA DIODE SILICON EPITAXIAL PIN TYPE

J D P 2 S 0 4 E

VHF~UHF BAND RF ATTENUATOR APPLICATIONS

Suitable for reducing set's size as a result from enabling highdensity mounting due to 2-pin small packages.

Low Capacitance Ratio : $C_T = 0.25 pF$ (Typ.)

Low Series Resistance : $r_S = 3 \Omega$ (Typ.)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Reverse Voltage	$ m v_R$	50	V
Foward Current	$\mathbf{I_F}$	50	mA
Junction Temperature	T_{j}	125	$^{\circ}\mathrm{C}$
Storage Temperature Range	$\mathrm{T_{stg}}$	-55~125	$^{\circ}\mathrm{C}$

CATHODE MARK **ESC JEDEC EIAJ TOSHIBA** 1-1G1A

Unit in mm

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Reverse Voltage	v_{R}	$I_R = 10 \mu A$	50	_	_	V
Reverse Current	$I_{ m R}$	$V_R = 50 V$	_	_	0.1	μ A
Forward Voltage	$V_{\mathbf{F}}$	$I_{ m F}=50{ m mA}$	_	0.95	1.0	V
Capacitance	C_{T}	$V_R = 50 V, f = 1 MHz$	_	0.25	0.4	рF
Series Resistance	$r_{\rm S}$	$I_F = 10 \text{ mA}, \text{ f} = 100 \text{ MHz}$		3.0	_	Ω

Signal level when capacitance is measured: $Vsig = 20 \, mV_{rms}$

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